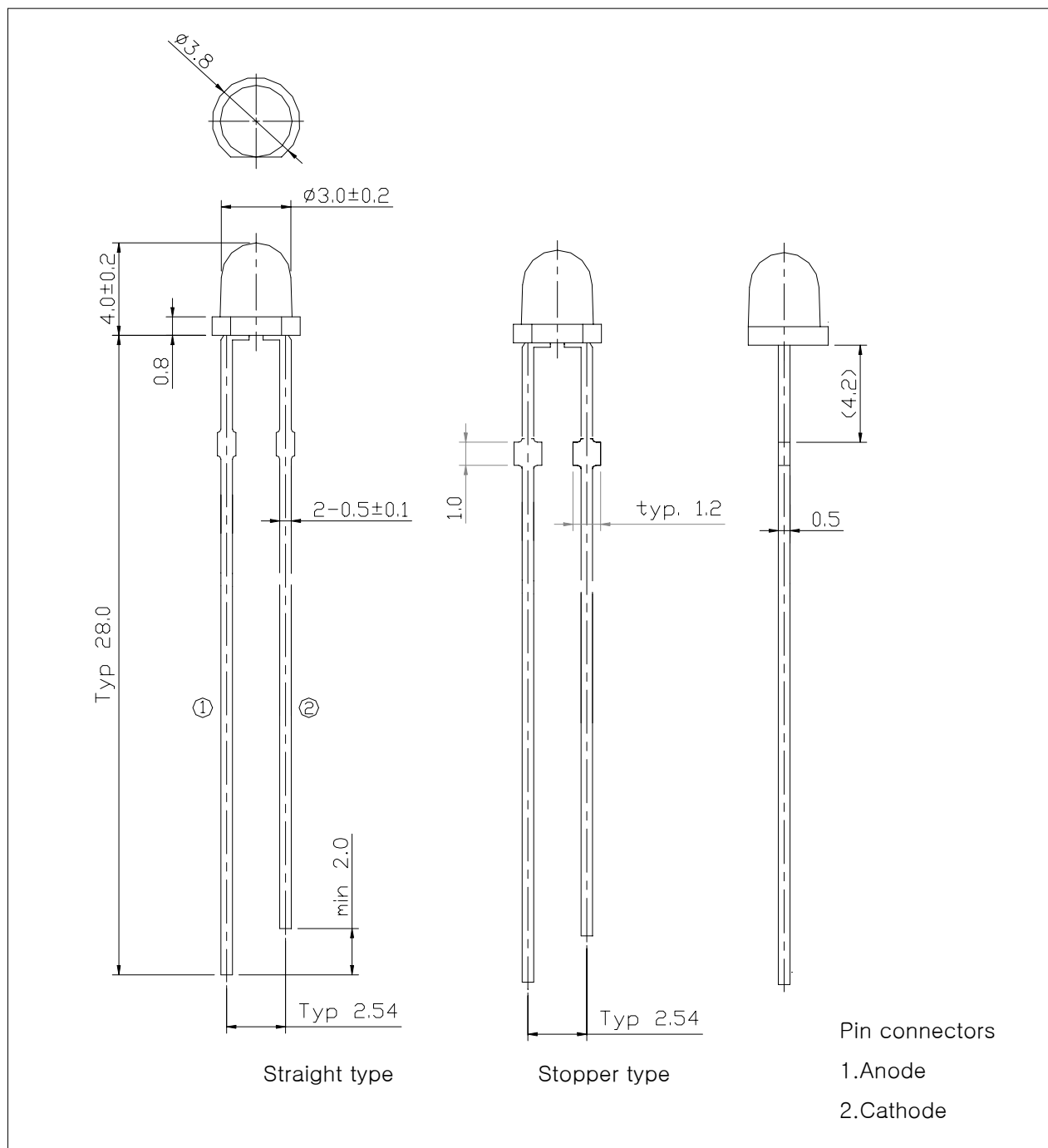


■ Features

- Colorless transparency lens type
- $\phi 3\text{mm}$ (T-1) all plastic mold type
- Wide view angle type
- High luminosity

■ Outline dimensions

(unit : mm)



Different and Better

■ Absolute maximum ratings

Characteristic	Symbol	Ratings	Unit
Power dissipation	P_D	120	mW
Forward Current	I_F	30	mA
* ¹ Peak Forward Current	I_{FP}	100	mA
Reverse Voltage	V_R	5	V
Operating Temperature	T_{opr}	-30~85	°C
Storage Temperature	T_{stg}	-40~100	°C
* ² Soldering Temperature	T_{sol}	260°C for 3 seconds	

*1.Duty ratio $\leq 1/10$, Pulse Width $\leq 10\text{msec}$

*2.Keep the distance more than 2.0mm from PCB to the bottom of LED package

■ Electrical – Optical Characteristics

($T_a=25^\circ\text{C}$)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Forward Voltage	V_F	$I_F=20\text{mA}$	–	2.0	2.5	V
Dominant Wavelength	λ_p	$I_F=20\text{mA}$	–	621	–	nm
Spectrum Bandwidth	$\Delta\lambda$	$I_F=20\text{mA}$	–	25	–	nm
Reverse Current	I_R	$V_R=5\text{V}$	–	–	10	uA
* ³ Half Angle	$\theta_{1/2}$	$I_F=20\text{mA}$	–	± 30	–	deg

*3. $\theta_{1/2}$ is the off-axis angle where the luminous intensity is 1/2 the peak intensity

■ Luminous intensity ranks

(Ta=25℃)

Iv RANK	Test Condition	Min.	Typ.	Max.	Unit
P	I _F = 20mA	1200	—	1700	mcd
Q		1700	—	2400	
R		2400	—	3400	
S		3400	—	4800	

* Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of ±11%.

* Intensity Measured : 0.01sr(CIE. LED_B)

■ Precautions On LED using

* To avoid optical difference, Please do not mix differently-ranked product.

■ Characteristic Diagrams

Fig. 1 I_F - V_F

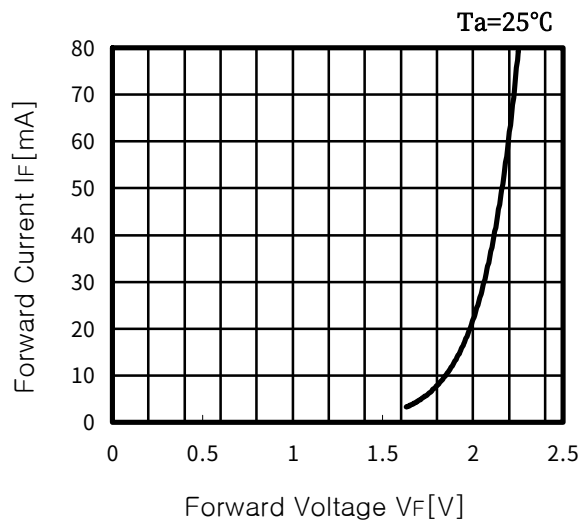


Fig. 2 I_V - I_F

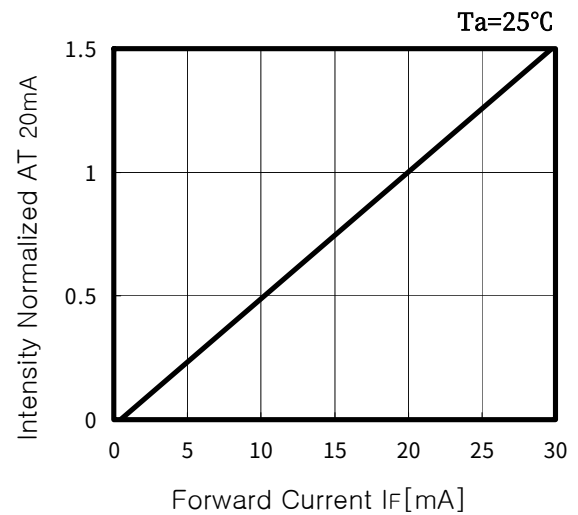


Fig. 3 Spectrum Distribution

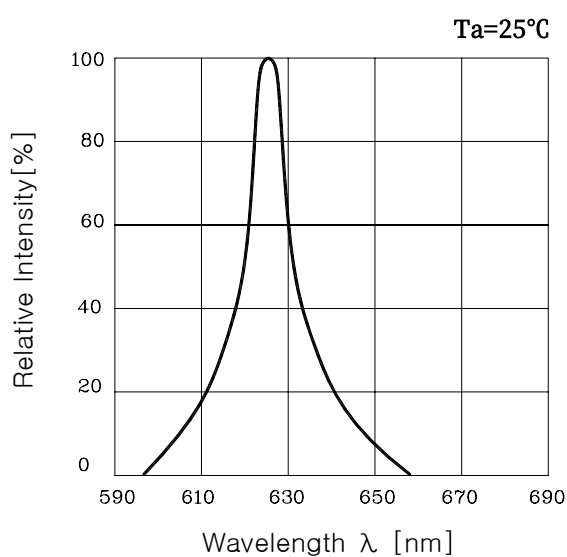


Fig. 4 Relative Intensity- T_a

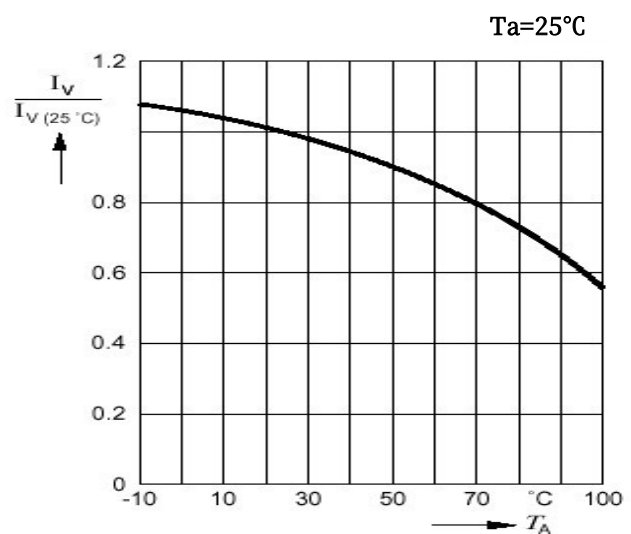
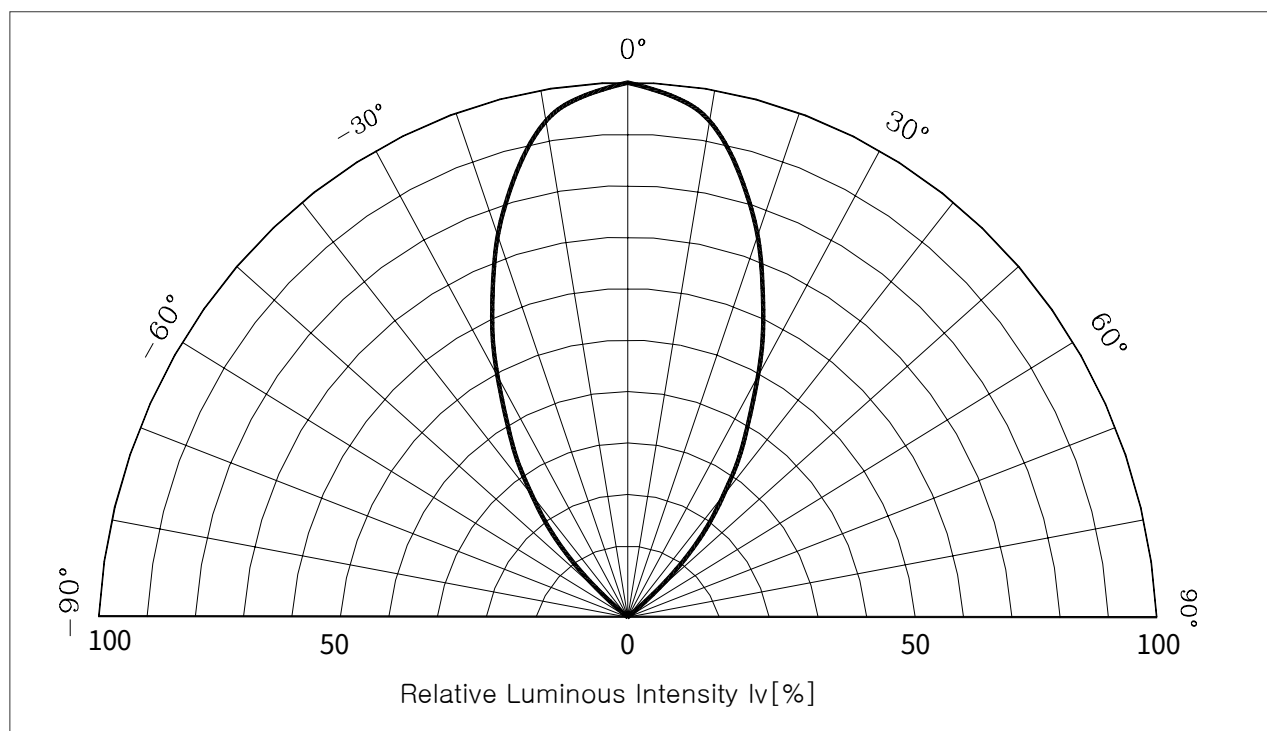


Fig. 5 Radiation Diagram



[illegible]